N THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s):

SHIMOKAWA, et al.

Filed:

October 9, 2001

For:

PB-FREE SOLDER-CONNECTED STRUCTURE AND

ELECTRONIC DEVICE

PRELIMINARY AMENDMENT

Assistant Commissioner for Patents Washington, D.C. 20231

October 9, 2001

Sir:

Please amend the above-identified application, prior to examination thereof, as follows:

IN THE SPECIFICATION

Page 1, between the title and the heading "TECHNICAL FIELD", please add the following new paragraph:

This application is a Continuation application of prior application Serial No. 09/581,631, filed June 15, 2000, which is a national stage application under 35 USC 371 of International (PCT) Application No. PCT/JP98/05565, filed

December 9, 1998.